



FEATURES

* Current transfer ratio

(CTR : MIN. 50% at $I_F\,{=}\,5mA,\,V_{CE}\,{=}\,5V$)

* Isolation voltage between input and output

(Viso = 3KVrms)

* Compact dual-in-line package 4 channels type

* Employs double transfer mold technology

* Marked as THP4

* ROHS compliance

* G : Halogen Free

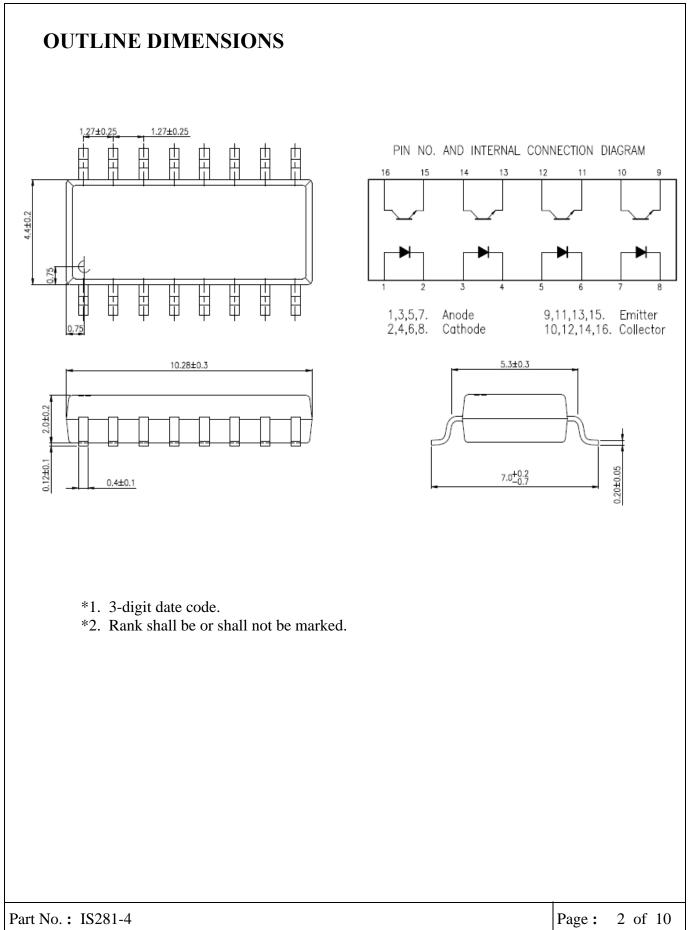
APPLICATIONS

- * Hybrid substrates that require high density mounting.
- * Programmable controllers
- * System appliances, measuring instruments

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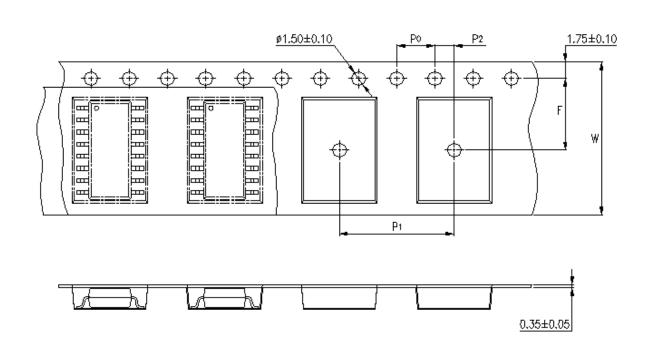
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Description	Symbol	Dimension in mm (inches)		
Tape wide	w	16 ± 0.3 (.47)		
Pitch of sprocket holes	P 0	4 ± 0.1 (.15)		
Distance of compartment	F P2	7.5 ± 0.1 (.217) 2 ± 0.1 (.079)		
Distance of compartment to compartment	P 1	12 ± 0.1 (.63)		

Quantities per Reel :

Package Type	
Quantities (pcs)	2000

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ABSOLUTE MAXIMUM RATING

(1a - 25 C)

		SYMBOL RATING U		UNIT		
	PARAMETER	STRIBUL	217	227	247	
	Forward Current	\mathbf{I}_{F}		50		mA
INPUT	Reverse Voltage	VR		6		V
Power Dissipation P 70		70	70			
	Collector - Emitter Voltage	VCEO	80		V	
	Emitter - Collector Voltage	VECO		7		V
OUTPUT	Collector Current	Ic		50		mA
	Collector Power Dissipation	Рс		150	100	mW
Total P	Power Dissipation	Ptot		200	170	mW
*1 Isolatio	on Voltage	Viso		3,750		Vrms
Operat	ing Temperature	Topr		-55 ~ +110		°C
Storage	e Temperature	Tstg		-55 ~ +150		°C
*2 Solderi	ng Temperature	Tsol		260 (10s)		°C

*1. AC For 1 Minute, $R.H. = 40 \sim 60\%$

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.
- *2. For 10 Seconds

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ELECTRICAL - OPTICAL CHARACTERISTICS

 $(Ta = 25^{\circ}C)$

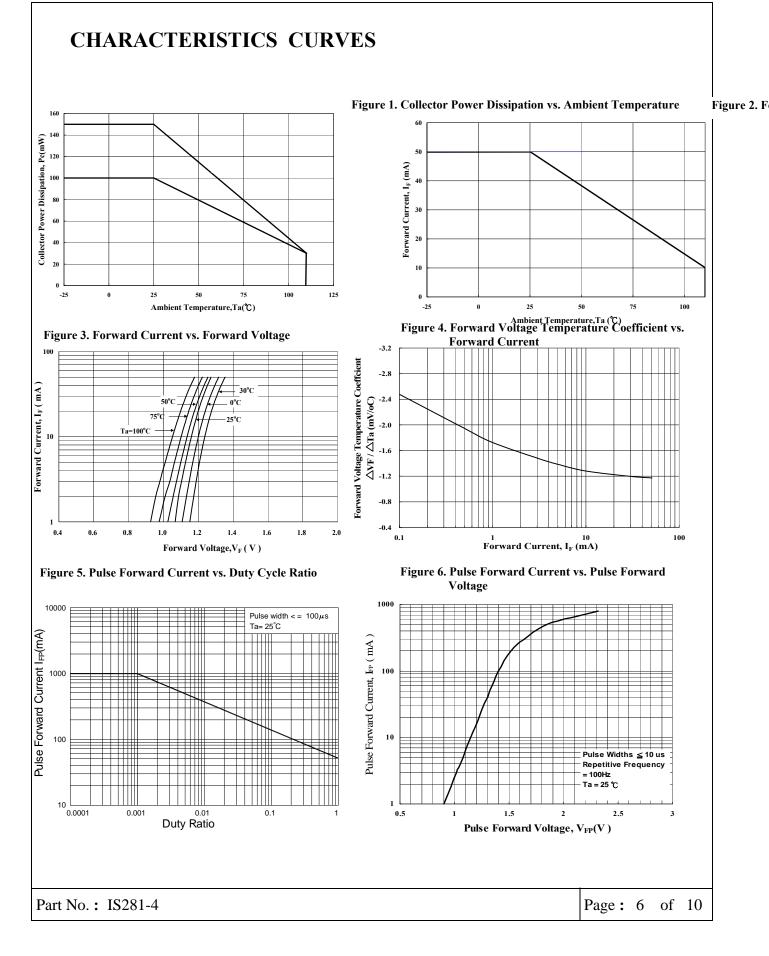
PAF	AMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
	Forward Voltage	V_{F}		1.2	1.4	v	IF=20mA
INPUT	Reverse Current	Ir	_	_	10	μΑ	V _R =4V
	Terminal Capacitance	Ct	_	30	250	pF	V=0, f=1KHz
	Collector Dark Current	Iceo	_	_	100	nA	Vce=50V, If=0
OUTPUT	Collector-Emitter Breakdown Voltage	BVCEO	80	_	_	v	Ic=0.1mA I _F =0
	Emitter-Collector Breakdown Voltage	BVECO	7	_	_	v	IE=10µA IF=0
	Collector Current	Ic	2.5	_	30	mA	IF=5mA
	*1 Current Transfer Ratio	CTR	50	_	600	%	Vce=5V
	Collector-Emitter Saturation Voltage	VCE(sat)	_	_	0.4	V	IF=2.4mA Ic=8mA
TRANSFER CHARACTERISTICS	Isolation Resistance	Riso	5×10 ¹⁰	1×10 ¹¹		Ω	DC500V 40 ~ 60% R.H.
	Floating Capacitance	C_{f}	_	0.6	1	pF	V=0, f=1MHz
	Response Time (Rise)	tr		3	18	μs	Vce=2V, Ic=2mA
	Response Time (Fall)	tſ		4	18	μs	R _L =100Ω

*1 CTR =
$$\frac{I_{C}}{I_{F}} \times 100\%$$

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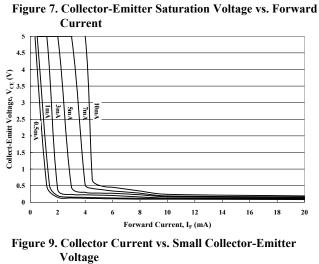
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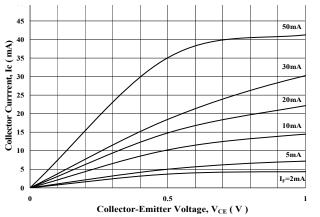




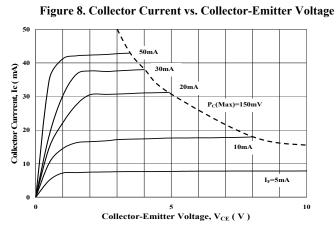


CHARACTERISTICS CURVES

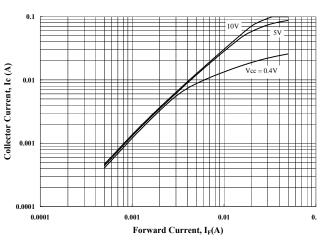


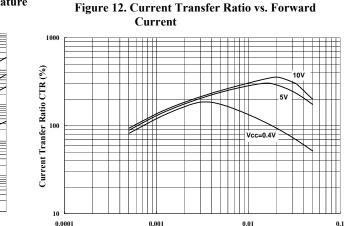












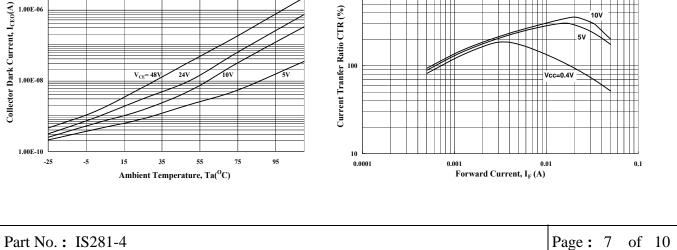






Figure 13. Collector-Emitter Saturation Voltage vs. Ambient Temperature

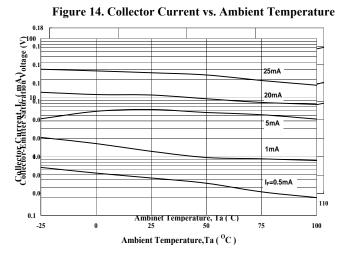
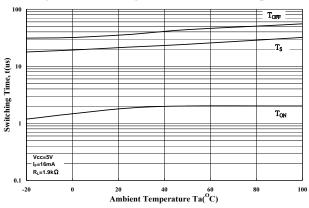
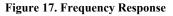


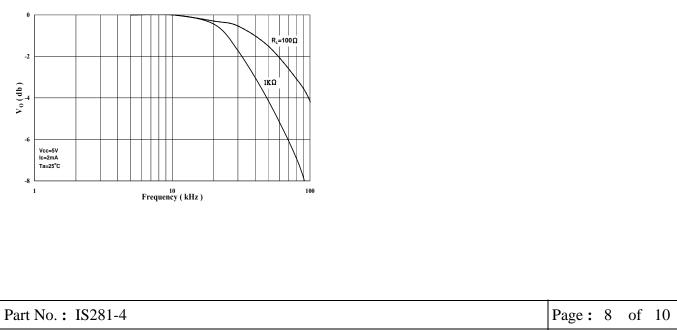
Figure 15. Switching Time vs. Load Resistance



Figure 16. Switching Time vs. Ambient Temperature

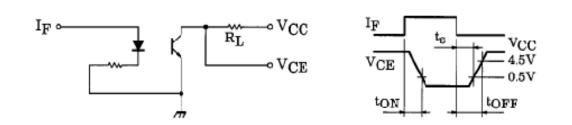








SWITCHING TIME TEST CIRCUIT

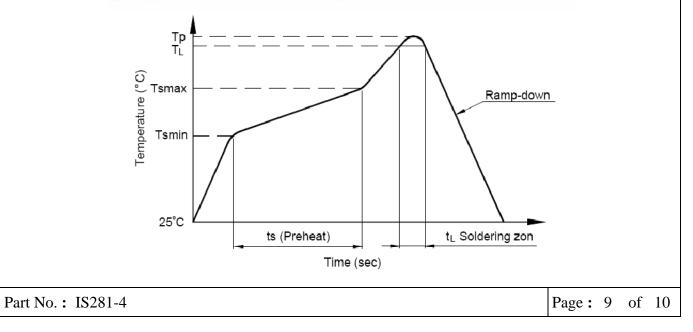


TEMPERATURE PROFILE OF SOLDERING REFLOW

- (1) One time soldering reflow is recommended within the condition of temperature and time profile shown below.
 - Wave solder

 260 °C / 10 sec
 - 2. IR reflow

Profile item	Condition		
Preheat			
- Temperature Min (Ts _{min})	150 °C		
- Temperature Max (Ts _{max})	180 °C		
- Time (min to max) (ts)	$90\pm30~\text{sec}$		
Soldering zone			
- Temperature (T _L)	250 °C		
- Time (t _L)	10~15 sec		
Peak temperature (Tp)	260 °C		
Ramp-down rate	3 ~ 6 °C / sec		





TEMPERATURE PROFILE OF SOLDERING REFLOW

(2) When using another soldering method such as infrated ray lamp, the temperature may rise partially in the mold of the device.

Keep the temperature on the package of the device within the condition of above (1)

Notes:

- Isocom is continually improving the quality, reliability, function or design and Isocom reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
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- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Do not immerse unit's body in solder paste.

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